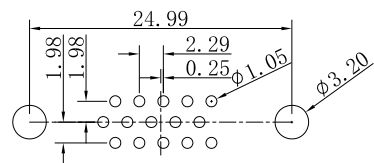
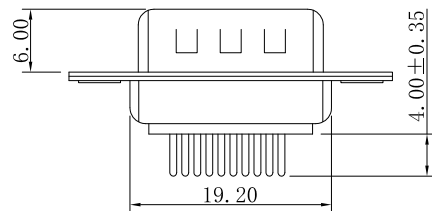
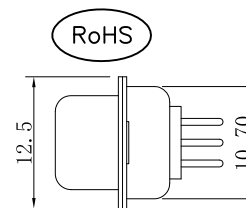


The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements

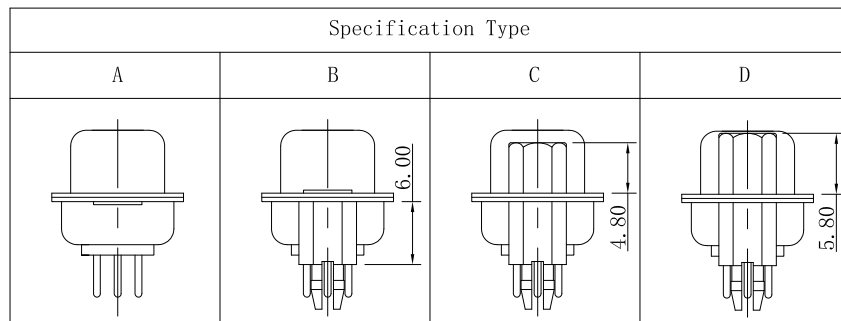


PCB layout

CHARACTERISTICS:

- 1、RATED VOLTAGE: 250V AC CD
- 2、RATED CURRENT: 3.0AMP
- 3、CONTACT RESISTANCE: 30mΩ Max.
- 4、INSULATION RESISTANCE: 1000 MΩ MIN.500V DC
- 5、Electric Pressure: Keeping 60 second in AC 500V/1mA
- 6、Operating temperature: -55℃~105℃
- 7、INSERTION/EXTRACTION FORCE PER CONTACT: 3.74Kg Max
0.33Kg Min.

Specification Type



ORDER INFORMTION

P/N:WLDBM0-151XXX052

Number of Contact

Contact Type
1: DIP

Plating Contact
1: Gold Flash
3: Au: 3U"
6: Au: 30U"

SCREW

Housing color
A: Black
S: Nature

A: Specification Type A
B: Specification Type B
C: Specification Type C
D: Specification Type D

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART. NO:	DWG. NO:		WanLian Teconology Co., Ltd
A0	NEW RELEASE	21. 01. 13		LINEAR	ANGLES	APPROVED	Wang_jr	21. 03. 11	WLDBM0-151XXX052	ENDE05		
			UNIT: mm	0.0±0.35	X° REF±6°	DESIGNER	Ding_Bo	21. 03. 11	TITLE: HDP 15M DIP		REV: A0	SHEET: 1/1
				0.00±0.25	X° ±3°	DRAWN	Ou_Jian	21. 03. 11				
			SIZE: A4	0.000±0.10	X° X'±2°							